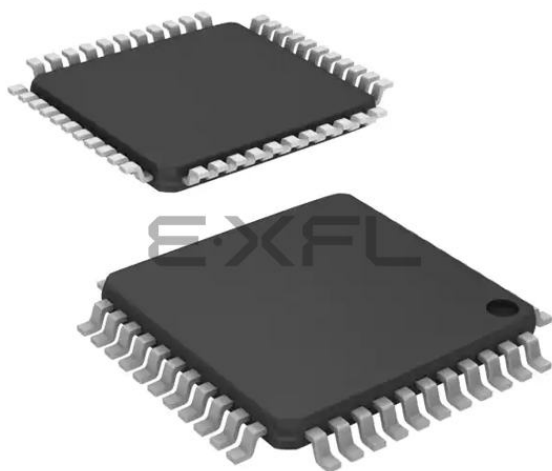




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Details

Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	40MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	32
Program Memory Size	24KB (12K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	1408 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18lf4539t-i-pt

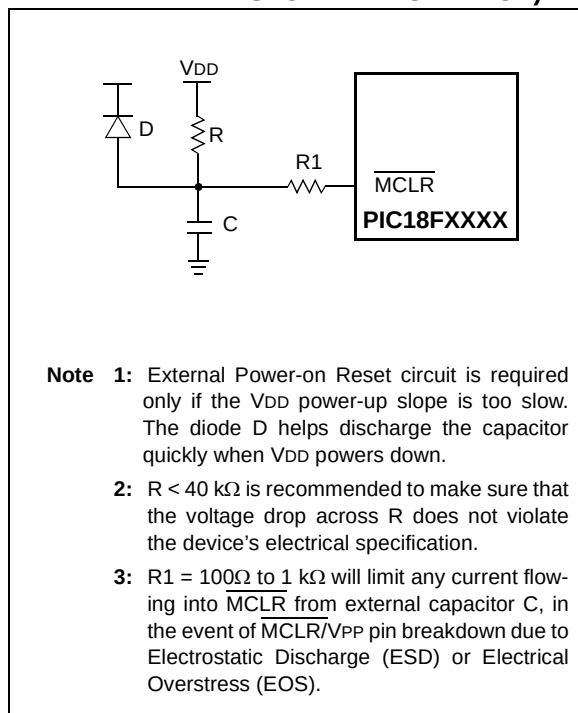
PIC18FXX39

3.1 Power-on Reset (POR)

A Power-on Reset pulse is generated on-chip when V_{DD} rise is detected. To take advantage of the POR circuitry, just tie the $\overline{MCLR}$ pin directly (or through a resistor) to V_{DD} . This will eliminate external RC components usually needed to create a Power-on Reset delay. A minimum rise rate for V_{DD} is specified (parameter D004). For a slow rise time, see Figure 3-2.

When the device starts normal operation (i.e., exits the RESET condition), device operating parameters (voltage, frequency, temperature, etc.) must be met to ensure operation. If these conditions are not met, the device must be held in RESET until the operating conditions are met.

FIGURE 3-2: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW V_{DD} POWER-UP)



3.2 Power-up Timer (PWRT)

The Power-up Timer provides a fixed nominal time-out (parameter 33) only on power-up from the POR. The Power-up Timer operates on an internal RC oscillator. The chip is kept in RESET as long as the PWRT is active. The PWRT's time delay allows V_{DD} to rise to an acceptable level. A configuration bit is provided to enable/disable the PWRT.

The power-up time delay will vary from chip-to-chip due to V_{DD} , temperature and process variation. See DC parameter D033 for details.

3.3 Oscillator Start-up Timer (OST)

The Oscillator Start-up Timer (OST) provides a 1024 oscillator cycle (from OSC1 input) delay after the PWRT delay is over (parameter 32). This ensures that the crystal oscillator or resonator has started and stabilized.

The OST time-out is invoked only for XT, LP and HS modes and only on Power-on Reset or wake-up from SLEEP.

3.4 PLL Lock Time-out

With the PLL enabled, the time-out sequence following a Power-on Reset is different from other Oscillator modes. A portion of the Power-up Timer is used to provide a fixed time-out that is sufficient for the PLL to lock to the main oscillator frequency. This PLL lock time-out (TPLL) is typically 2 ms and follows the Oscillator Start-up Time-out (OST).

3.5 Brown-out Reset (BOR)

A configuration bit, BOREN, can disable (if clear/programmed), or enable (if set) the Brown-out Reset circuitry. If V_{DD} falls below parameter D005 for greater than parameter 35, the brown-out situation will reset the chip. A RESET may not occur if V_{DD} falls below parameter D005 for less than parameter 35. The chip will remain in Brown-out Reset until V_{DD} rises above BV_{DD} . If the Power-up Timer is enabled, it will be invoked after V_{DD} rises above BV_{DD} ; it then will keep the chip in RESET for an additional time delay (parameter 33). If V_{DD} drops below BV_{DD} while the Power-up Timer is running, the chip will go back into a Brown-out Reset and the Power-up Timer will be initialized. Once V_{DD} rises above BV_{DD} , the Power-up Timer will execute the additional time delay.

3.6 Time-out Sequence

On power-up, the time-out sequence is as follows: First, PWRT time-out is invoked after the POR time delay has expired. Then, OST is activated. The total time-out will vary based on oscillator configuration and the status of the PWRT. For example, in RC mode with the PWRT disabled, there will be no time-out at all. Figure 3-3, Figure 3-4, Figure 3-5, Figure 3-6 and Figure 3-7 depict time-out sequences on power-up.

Since the time-outs occur from the POR pulse, if $\overline{MCLR}$ is kept low long enough, the time-outs will expire. Bringing $\overline{MCLR}$ high will begin execution immediately (Figure 3-5). This is useful for testing purposes or to synchronize more than one PIC18FXXX device operating in parallel.

Table 3-2 shows the RESET conditions for some Special Function Registers, while Table 3-3 shows the RESET conditions for all the registers.

PIC18FXX39

TABLE 4-1: SPECIAL FUNCTION REGISTER MAP

Address	Name	Address	Name	Address	Name	Address	Name
FFFh	TOSU	FDFh	INDF2 ⁽³⁾	FBFh	CCPR1H	F9Fh	IPR1
FFEh	TOSH	FDEh	POSTINC2 ⁽³⁾	FBEh	CCPR1L*	F9Eh	PIR1
FFDh	TOSL	FDDh	POSTDEC2 ⁽³⁾	FBDh	CCP1CON*	F9Dh	PIE1
FFCh	STKPTR	FDCh	PREINC2 ⁽³⁾	FBCh	CCPR2H	F9Ch	—
FFBh	PCLATU	FDBh	PLUSW2 ⁽³⁾	FBHh	CCPR2L*	F9Bh	—
FFAh	PCLATH	FDAh	FSR2H	FBAh	CCP2CON*	F9Ah	—
FF9h	PCL	FD9h	FSR2L	FB9h	—	F99h	—
FF8h	TBLPTRU	FD8h	STATUS	FB8h	—	F98h	—
FF7h	TBLPTRH	FD7h	TMR0H	FB7h	—	F97h	—
FF6h	TBLPTRL	FD6h	TMR0L	FB6h	—	F96h	TRISE ⁽²⁾
FF5h	TABLAT	FD5h	T0CON	FB5h	—	F95h	TRISD ⁽²⁾
FF4h	PRODH	FD4h	—	FB4h	—	F94h	TRISC ⁽⁴⁾
FF3h	PRODL	FD3h	OSCCON*	FB3h	TMR3H	F93h	TRISB
FF2h	INTCON	FD2h	LVDCON	FB2h	TMR3L	F92h	TRISA
FF1h	INTCON2	FD1h	WDTCON	FB1h	T3CON	F91h	—
FF0h	INTCON3	FD0h	RCON	FB0h	—	F90h	—
FEFh	INDF0 ⁽³⁾	FCFh	TMR1H	FAFh	SPBRG	F8Fh	—
FEEh	POSTINC0 ⁽³⁾	FCEh	TMR1L	FAEh	RCREG	F8Eh	—
FEDh	POSTDEC0 ⁽³⁾	FCDh	T1CON	FADh	TXREG	F8Dh	LATE ⁽²⁾
FECh	PREINC0 ⁽³⁾	FCCh	TMR2*	FACH	TXSTA	F8Ch	LATD ⁽²⁾
FEBh	PLUSW0 ⁽³⁾	FCBh	PR2*	FABh	RCSTA	F8Bh	LATC ⁽⁴⁾
FEAh	FSR0H	FCAh	T2CON*	FAAh	—	F8Ah	LATB
FE9h	FSR0L	FC9h	SSPBUF	FA9h	EEADR	F89h	LATA
FE8h	WREG	FC8h	SSPADD	FA8h	EEDATA	F88h	—
FE7h	INDF1 ⁽³⁾	FC7h	SSPSTAT	FA7h	EECON2	F87h	—
FE6h	POSTINC1 ⁽³⁾	FC6h	SSPCON1	FA6h	EECON1	F86h	—
FE5h	POSTDEC1 ⁽³⁾	FC5h	SSPCON2	FA5h	—	F85h	—
FE4h	PREINC1 ⁽³⁾	FC4h	ADRESH	FA4h	—	F84h	PORTE ⁽²⁾
FE3h	PLUSW1 ⁽³⁾	FC3h	ADRESL	FA3h	—	F83h	PORTD ⁽²⁾
FE2h	FSR1H	FC2h	ADCON0	FA2h	IPR2	F82h	PORTC ⁽⁴⁾
FE1h	FSR1L	FC1h	ADCON1	FA1h	PIR2	F81h	PORTB
FE0h	BSR	FC0h	—	FA0h	PIE2	F80h	PORTA

* These registers are retained to maintain compatibility with PIC18FXX2 devices; however, one or more bits are reserved in PIC18FXX39 devices. Users should not alter the values of these bits.

Note 1: Unimplemented registers are read as '0'.

2: This register is not available on PIC18F2X39 devices.

3: This is not a physical register.

4: Bits 1 and 2 are reserved; users should not alter their values.

5.5 Writing to FLASH Program Memory

The minimum programming block is 4 words or 8 bytes. Word or byte programming is not supported.

Table Writes are used internally to load the holding registers needed to program the FLASH memory. There are 8 holding registers used by the Table Writes for programming.

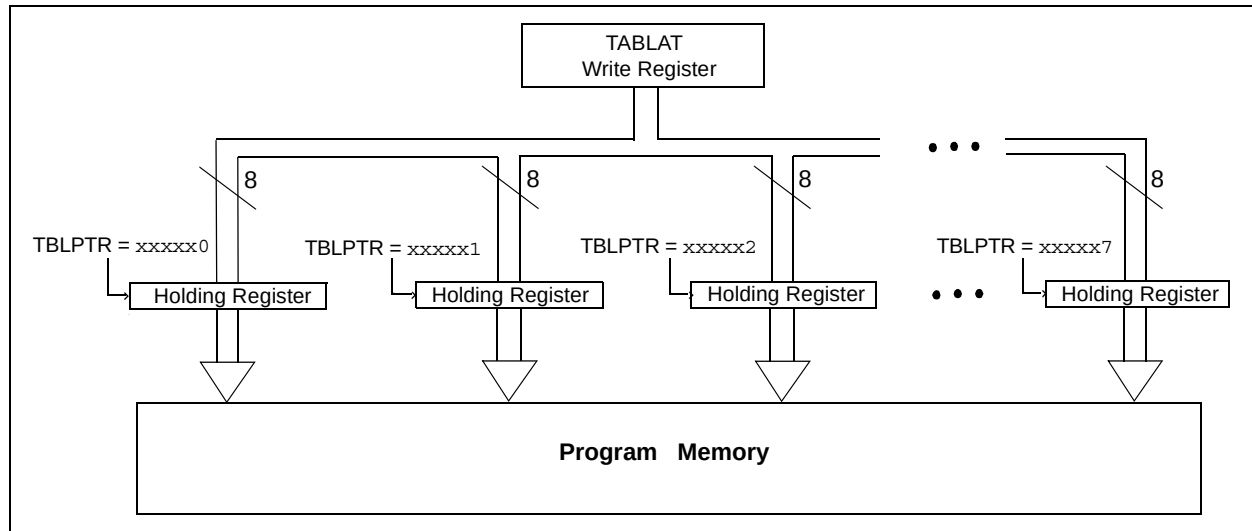
Since the Table Latch (TABLAT) is only a single byte, the TBLWT instruction has to be executed 8 times for each programming operation. All of the Table Write

operations will essentially be short writes, because only the holding registers are written. At the end of updating 8 registers, the EECON1 register must be written to, to start the programming operation with a long write.

The long write is necessary for programming the internal FLASH. Instruction execution is halted while in a long write cycle. The long write will be terminated by the internal programming timer.

The EEPROM on-chip timer controls the write time. The write/erase voltages are generated by an on-chip charge pump rated to operate over the voltage range of the device for byte or word operations.

FIGURE 5-5: TABLE WRITES TO FLASH PROGRAM MEMORY



5.5.1 FLASH PROGRAM MEMORY WRITE SEQUENCE

The sequence of events for programming an internal program memory location should be:

1. Read 64 bytes into RAM.
2. Update data values in RAM as necessary.
3. Load Table Pointer with address being erased.
4. Do the row erase procedure.
5. Load Table Pointer with address of first byte being written.
6. Write the first 8 bytes into the holding registers with auto-increment (TBLWT*+ or TBLWT+*).
7. Set EEPGD bit to point to program memory, clear the CFGS bit to access program memory, and set WREN to enable byte writes.
8. Disable interrupts.
9. Write 55h to EECON2.

10. Write AAh to EECON2.
11. Set the WR bit. This will begin the write cycle.
12. The CPU will stall for duration of the write (about 2 ms using internal timer).
13. Re-enable interrupts.
14. Repeat steps 6-14 seven times, to write 64 bytes.
15. Verify the memory (Table Read).

This procedure will require about 18 ms to update one row of 64 bytes of memory. An example of the required code is given in Example 5-3.

Note: Before setting the WR bit, the table pointer address needs to be within the intended address range of the 8 bytes in the holding registers.

REGISTER 8-3: INTCON3 REGISTER

R/W-1	R/W-1	U-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
INT2IP ⁽¹⁾	INT1IP ⁽¹⁾	—	INT2IE	INT1IE	—	INT2IF	INT1IF
bit 7							
							bit 0

- bit 7 **INT2IP⁽¹⁾**: INT2 External Interrupt Priority bit
 1 = High priority
 0 = Low priority
- bit 6 **INT1IP⁽¹⁾**: INT1 External Interrupt Priority bit
 1 = High priority
 0 = Low priority
- bit 5 **Unimplemented**: Read as '0'
- bit 4 **INT2IE**: INT2 External Interrupt Enable bit
 1 = Enables the INT2 external interrupt
 0 = Disables the INT2 external interrupt
- bit 3 **INT1IE**: INT1 External Interrupt Enable bit
 1 = Enables the INT1 external interrupt
 0 = Disables the INT1 external interrupt
- bit 2 **Unimplemented**: Read as '0'
- bit 1 **INT2IF**: INT2 External Interrupt Flag bit
 1 = The INT2 external interrupt occurred (must be cleared in software)
 0 = The INT2 external interrupt did not occur
- bit 0 **INT1IF**: INT1 External Interrupt Flag bit
 1 = The INT1 external interrupt occurred (must be cleared in software)
 0 = The INT1 external interrupt did not occur
- Note 1:** Maintain this bit cleared (= 0).

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
 - n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

Note: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the global enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows for software polling.

10.1 Timer0 Operation

Timer0 can operate as a timer or as a counter.

Timer mode is selected by clearing the T0CS bit. In Timer mode, the Timer0 module will increment every instruction cycle (without prescaler). If the TMR0L register is written, the increment is inhibited for the following two instruction cycles. The user can work around this by writing an adjusted value to the TMR0L register.

Counter mode is selected by setting the T0CS bit. In Counter mode, Timer0 will increment, either on every rising or falling edge of pin RA4/T0CKI. The incrementing edge is determined by the Timer0 Source Edge Select bit (T0SE). Clearing the T0SE bit selects the rising edge. Restrictions on the external clock input are discussed below.

When an external clock input is used for Timer0, it must meet certain requirements. The requirements ensure the external clock can be synchronized with the internal phase clock (Tosc). Also, there is a delay in the actual incrementing of Timer0 after synchronization.

10.2 Prescaler

An 8-bit counter is available as a prescaler for the Timer0 module. The prescaler is not readable or writable.

The PSA and T0PS2:T0PS0 bits determine the prescaler assignment and prescale ratio.

Clearing bit PSA will assign the prescaler to the Timer0 module. When the prescaler is assigned to the Timer0 module, prescale values in power-of-2 increments, from 1:2 through 1:256, are selectable.

When assigned to the Timer0 module, all instructions writing to the TMR0L register (e.g., `CLRF TMR0`, `MOVWF TMR0`, `BSF TMR0`, etc.) will clear the prescaler count.

Note: Writing to TMR0L when the prescaler is assigned to Timer0 will clear the prescaler count, but will not change the prescaler assignment.

10.2.1 SWITCHING PRESCALER ASSIGNMENT

The prescaler assignment is fully under software control; it can be changed “on-the-fly” during program execution.

10.3 Timer0 Interrupt

The TMR0 interrupt is generated when the TMR0 register overflows from FFh to 00h in 8-bit mode, or FFFFh to 0000h in 16-bit mode. This overflow sets the TMR0IF bit. The interrupt can be masked by clearing the TMR0IE bit. The TMR0IE bit must be cleared in software by the Timer0 module Interrupt Service Routine before re-enabling this interrupt. The TMR0 interrupt cannot awaken the processor from SLEEP, since the timer is shut-off during SLEEP.

10.4 16-bit Mode Timer Reads and Writes

TMR0H is not the high byte of the timer/counter in 16-bit mode, but is actually a buffered version of the high byte of Timer0 (see Figure 10-2). The high byte of the Timer0 counter/timer is not directly readable nor writable. TMR0H is updated with the contents of the high byte of Timer0 during a read of TMR0L. This provides the ability to read all 16 bits of Timer0 without having to verify that the read of the high and low byte were valid, due to a rollover between successive reads of the high and low byte.

A write to the high byte of Timer0 must also take place through the TMR0H buffer register. Timer0 high byte is updated with the contents of TMR0H when a write occurs to TMR0L. This allows all 16 bits of Timer0 to be updated at once.

TABLE 10-1: REGISTERS ASSOCIATED WITH TIMER0

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on All Other RESETS
TMR0L	Timer0 Module Low Byte Register								xxxx xxxx	uuuu uuuu
TMR0H	Timer0 Module High Byte Register								0000 0000	0000 0000
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	0000 000u
T0CON	TMR0ON	T08BIT	T0CS	T0SE	PSA	T0PS2	T0PS1	T0PS0	1111 1111	1111 1111
TRISA	—	PORTA Data Direction Register							-111 1111	-111 1111

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by Timer0.

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11.1 Timer1 Operation

Timer1 can operate in one of these modes:

- As a timer
- As a synchronous counter
- As an asynchronous counter

The Operating mode is determined by the clock select bit, TMR1CS (T1CON<1>). When TMR1CS = 0, Timer1 increments every instruction cycle. When TMR1CS = 1, Timer1 increments on every rising edge of the external clock input.

FIGURE 11-1: TIMER1 BLOCK DIAGRAM

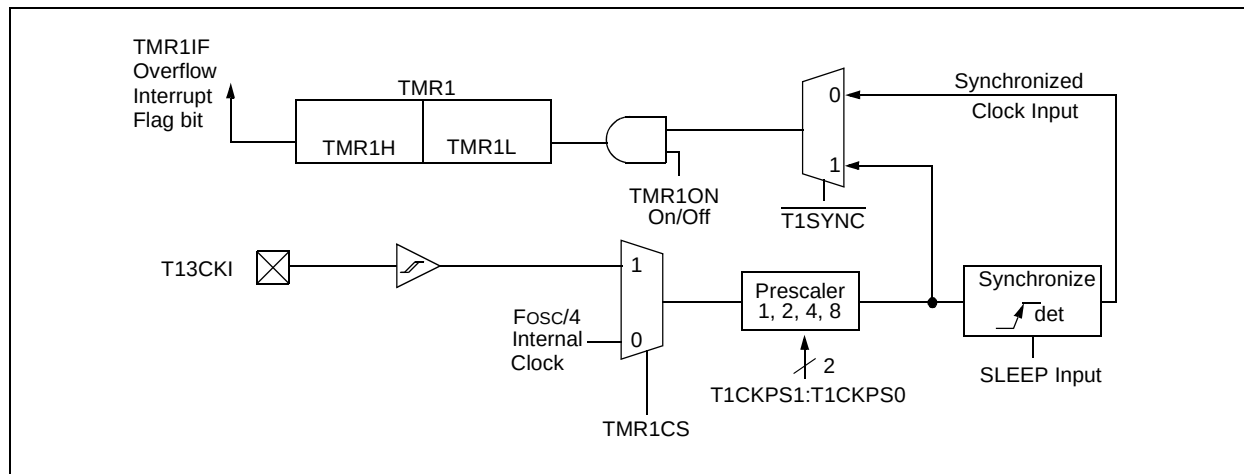
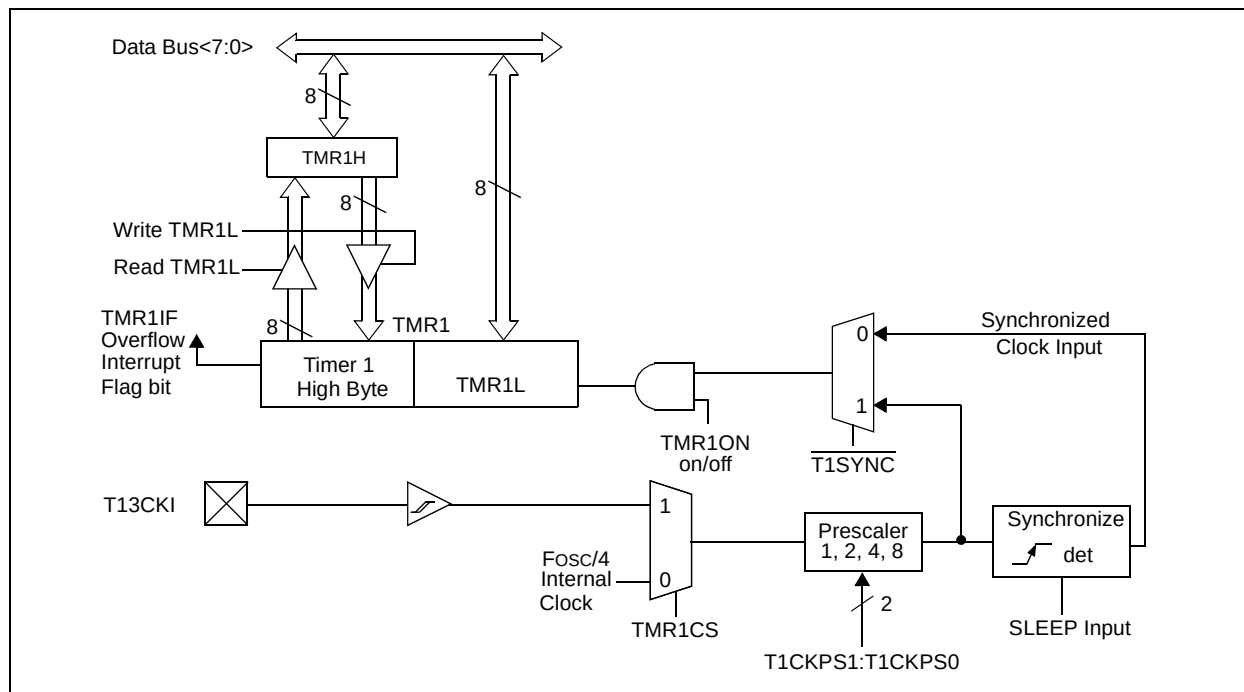


FIGURE 11-2: TIMER1 BLOCK DIAGRAM: 16-BIT READ/WRITE MODE



16.3.3 ENABLING SPI I/O

To enable the serial port, SSP Enable bit, SSPEN (SSPCON1<5>), must be set. To reset or reconfigure SPI mode, clear the SSPEN bit, re-initialize the SSPCON registers, and then set the SSPEN bit. This configures the SDI, SDO, SCK, and SS pins as serial port pins. For the pins to behave as the serial port function, some must have their data direction bits (in the TRIS register) appropriately programmed. That is:

- SDI is automatically controlled by the SPI module
- SDO must have TRISC<5> bit cleared
- SCK (Master mode) must have TRISC<3> bit cleared
- SCK (Slave mode) must have TRISC<3> bit set
- $\overline{SS}$ must have TRISC<4> bit set

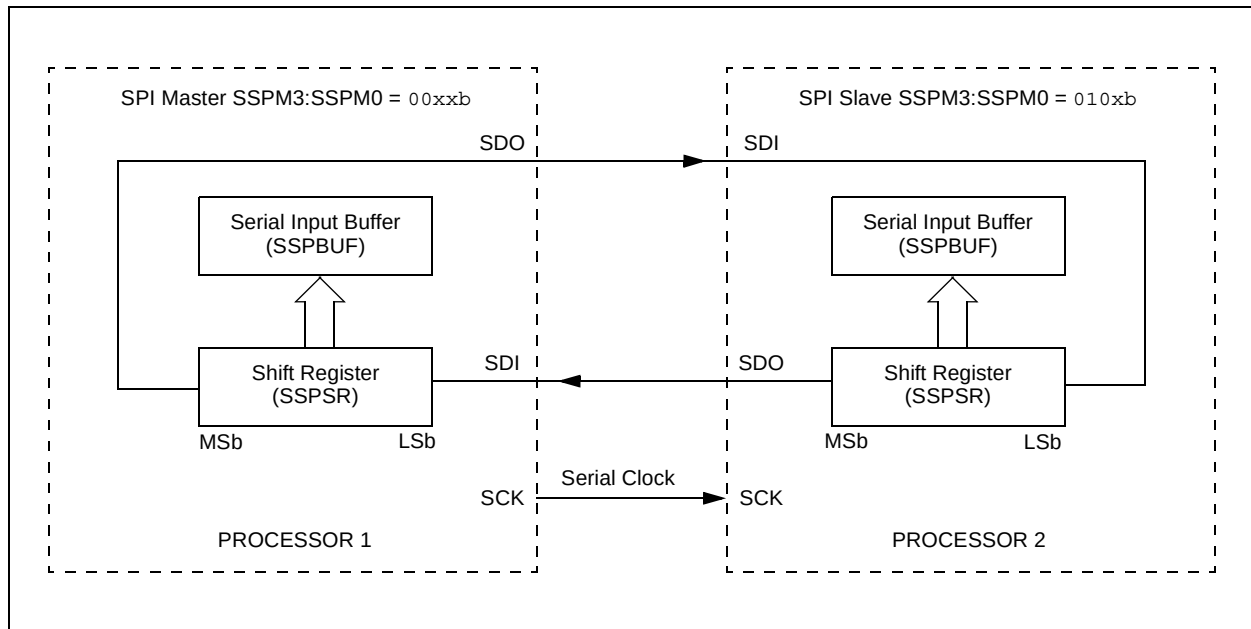
Any serial port function that is not desired may be overridden by programming the corresponding data direction (TRIS) register to the opposite value.

16.3.4 TYPICAL CONNECTION

Figure 16-2 shows a typical connection between two microcontrollers. The master controller (Processor 1) initiates the data transfer by sending the SCK signal. Data is shifted out of both shift registers on their programmed clock edge, and latched on the opposite edge of the clock. Both processors should be programmed to the same Clock Polarity (CKP), then both controllers would send and receive data at the same time. Whether the data is meaningful (or dummy data) depends on the application software. This leads to three scenarios for data transmission:

- Master sends data — Slave sends dummy data
- Master sends data — Slave sends data
- Master sends dummy data — Slave sends data

FIGURE 16-2: SPI MASTER/SLAVE CONNECTION



REGISTER 16-3: SSPSTAT: MSSP STATUS REGISTER (I²C MODE)

R/W-0	R/W-0	R-0	R-0	R-0	R-0	R-0	R-0
SMP	CKE	D/A	P	S	R/W	UA	BF
bit 7							bit 0

bit 7 **SMP:** Slew Rate Control bit

In Master or Slave mode:

- 1 = Slew rate control disabled for Standard Speed mode (100 kHz and 1 MHz)
- 0 = Slew rate control enabled for High Speed mode (400 kHz)

bit 6 **CKE:** SMBus Select bit

In Master or Slave mode:

- 1 = Enable SMBus specific inputs
- 0 = Disable SMBus specific inputs

bit 5 **D/A:** Data/Address bit

In Master mode:

Reserved

In Slave mode:

- 1 = Indicates that the last byte received or transmitted was data
- 0 = Indicates that the last byte received or transmitted was address

bit 4 **P:** STOP bit

- 1 = Indicates that a STOP bit has been detected last
- 0 = STOP bit was not detected last

Note: This bit is cleared on RESET and when SSPEN is cleared.

bit 3 **S:** START bit

- 1 = Indicates that a START bit has been detected last
- 0 = START bit was not detected last

Note: This bit is cleared on RESET and when SSPEN is cleared.

bit 2 **R/W:** Read/Write bit Information (I²C mode only)

In Slave mode:

- 1 = Read
- 0 = Write

Note: This bit holds the R/W bit information following the last address match. This bit is only valid from the address match to the next START bit, STOP bit, or not ACK bit.

In Master mode:

- 1 = Transmit is in progress
- 0 = Transmit is not in progress

Note: ORing this bit with SEN, RSEN, PEN, RCEN, or ACKEN will indicate if the MSSP is in IDLE mode.

bit 1 **UA:** Update Address (10-bit Slave mode only)

- 1 = Indicates that the user needs to update the address in the SSPADD register
- 0 = Address does not need to be updated

bit 0 **BF:** Buffer Full Status bit

In Transmit mode:

- 1 = Receive complete, SSPBUF is full
- 0 = Receive not complete, SSPBUF is empty

In Receive mode:

- 1 = Data transmit in progress (does not include the ACK and STOP bits), SSPBUF is full
- 0 = Data transmit complete (does not include the ACK and STOP bits), SSPBUF is empty

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown

16.4.9 I²C MASTER MODE REPEATED START CONDITION TIMING

A Repeated START condition occurs when the RSEN bit (SSPCON2<1>) is programmed high and the I²C logic module is in the IDLE state. When the RSEN bit is set, the SCL pin is asserted low. When the SCL pin is sampled low, the baud rate generator is loaded with the contents of SSPADD<5:0> and begins counting. The SDA pin is released (brought high) for one baud rate generator count (TBRG). When the baud rate generator times out, if SDA is sampled high, the SCL pin will be de-asserted (brought high). When SCL is sampled high, the baud rate generator is reloaded with the contents of SSPADD<6:0> and begins counting. SDA and SCL must be sampled high for one TBRG. This action is then followed by assertion of the SDA pin (SDA = 0) for one TBRG while SCL is high. Following this, the RSEN bit (SSPCON2<1>) will be automatically cleared and the baud rate generator will not be reloaded, leaving the SDA pin held low. As soon as a START condition is detected on the SDA and SCL pins, the S bit (SSPSTAT<3>) will be set. The SSPIF bit will not be set until the baud rate generator has timed out.

Note 1: If RSEN is programmed while any other event is in progress, it will not take effect.

2: A bus collision during the Repeated START condition occurs if:

- SDA is sampled low when SCL goes from low to high.
- SCL goes low before SDA is asserted low. This may indicate that another master is attempting to transmit a data "1".

Immediately following the SSPIF bit getting set, the user may write the SSPBUF with the 7-bit address in 7-bit mode, or the default first address in 10-bit mode. After the first eight bits are transmitted and an ACK is received, the user may then transmit an additional eight bits of address (10-bit mode) or eight bits of data (7-bit mode).

16.4.9.1 WCOL Status Flag

If the user writes the SSPBUF when a Repeated START sequence is in progress, the WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

Note: Because queueing of events is not allowed, writing of the lower 5 bits of SSPCON2 is disabled until the Repeated START condition is complete.

FIGURE 16-20: REPEAT START CONDITION WAVEFORM

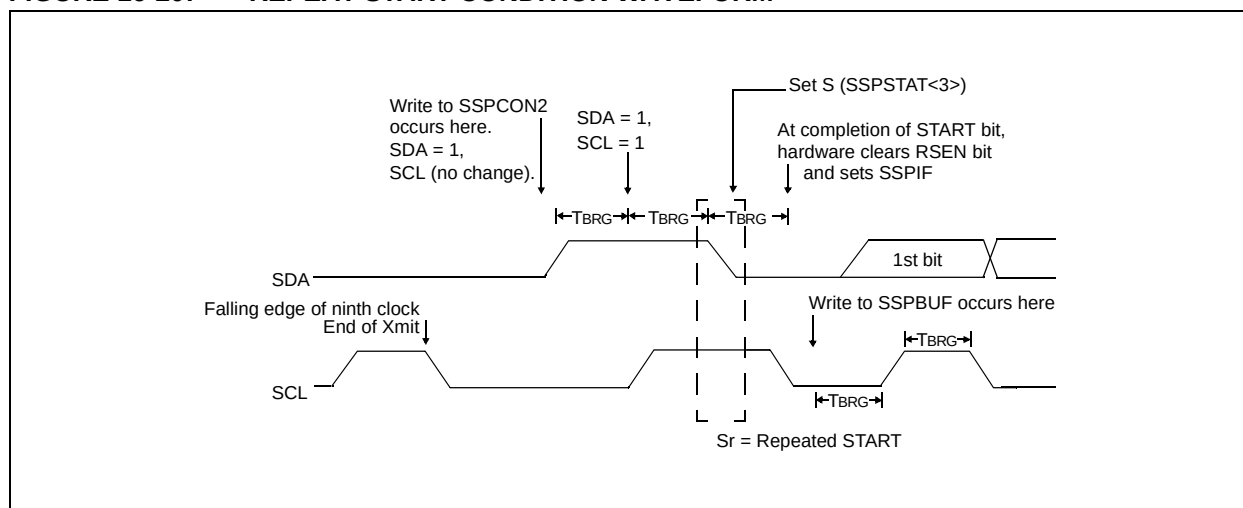


FIGURE 17-2: ASYNCHRONOUS TRANSMISSION

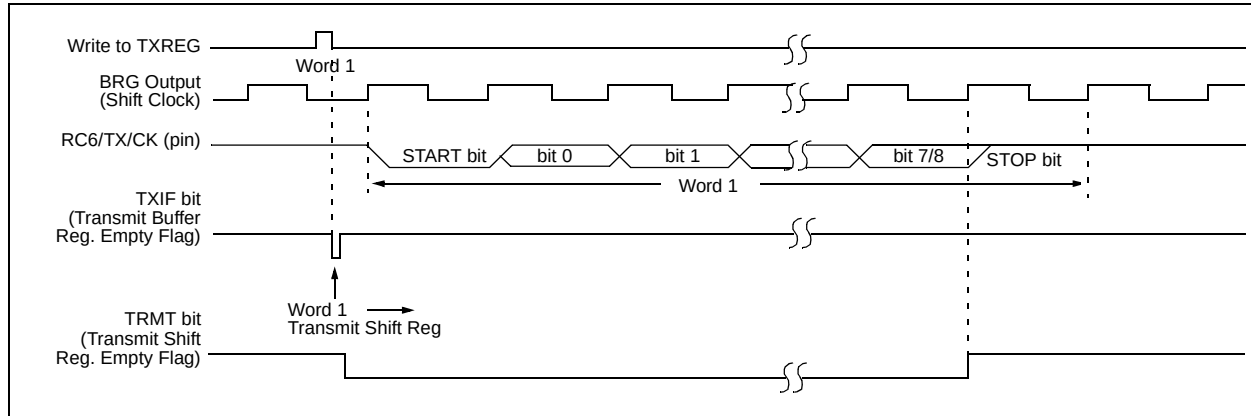


FIGURE 17-3: ASYNCHRONOUS TRANSMISSION (BACK TO BACK)

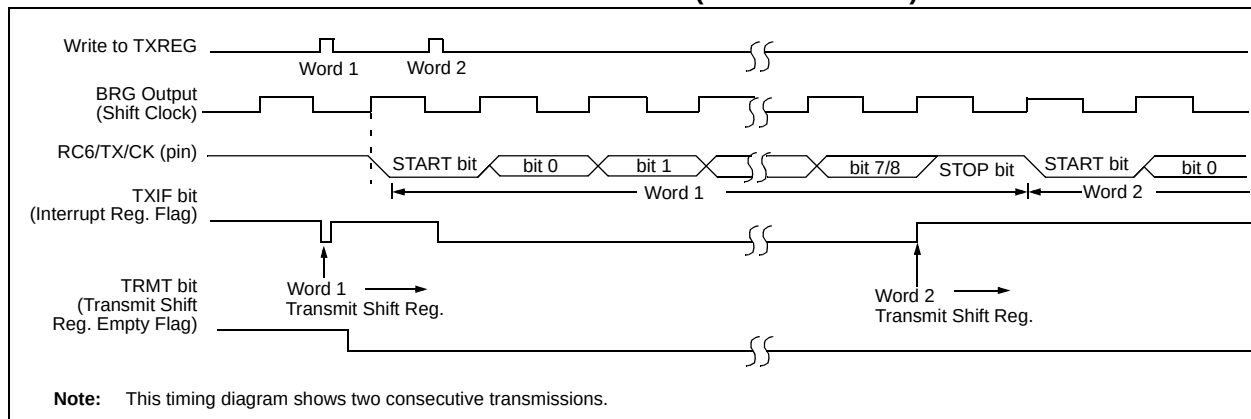


TABLE 17-6: REGISTERS ASSOCIATED WITH ASYNCHRONOUS TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on All Other RESETS
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	0000 000x	0000 000u
PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSPIF	—	TMR2IF	TMR1IF	0000 0000	0000 0000
PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSPIE	—	TMR2IE	TMR1IE	0000 0000	0000 0000
IPR1	PSPIP ⁽¹⁾	ADIP	RCIP	TXIP	SSPIP	—	TMR2IP	TMR1IP	0000 0000	0000 0000
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 -00x	0000 -00x
TXREG	USART Transmit Register								0000 0000	0000 0000
TXSTA	CSRC	TX9	TXEN	SYNC	—	BRGH	TRMT	TX9D	0000 -010	0000 -010
SPBRG	Baud Rate Generator Register								0000 0000	0000 0000

Legend: x = unknown, - = unimplemented locations read as '0'.

Shaded cells are not used for Asynchronous Transmission.

Note 1: The PSPIF, PSPIE and PSPIP bits are reserved on the PIC18F2X39 devices; always maintain these bits clear.

To calculate the minimum acquisition time, Equation 18-1 may be used. This equation assumes that 1/2 LSB error is used (1024 steps for the A/D). The 1/2 LSB error is the maximum error allowed for the A/D to meet its specified resolution.

EQUATION 18-1: ACQUISITION TIME

$$\begin{aligned} \text{TACQ} &= \text{Amplifier Settling Time} + \text{Holding Capacitor Charging Time} + \text{Temperature Coefficient} \\ &= \text{TAMP} + \text{TC} + \text{Tcoff} \end{aligned}$$

EQUATION 18-2: A/D MINIMUM CHARGING TIME

$$\begin{aligned} \text{VHOLD} &= (\text{VREF} - (\text{VREF}/2048)) \cdot (1 - e^{(-\text{TC}/\text{CHOLD}(\text{RIC} + \text{RSS} + \text{RS})))} \\ \text{or} \\ \text{TC} &= -(120 \text{ pF})(1 \text{ k}\Omega + \text{RSS} + \text{RS}) \ln(1/2048) \end{aligned}$$

Example 18-1 shows the calculation of the minimum required acquisition time, TACQ. This calculation is based on the following application system assumptions:

- CHOLD = 120 pF
- RS = 2.5 k Ω
- Conversion Error $\leq$ 1/2 LSB
- VDD = 5V $\rightarrow$ RSS = 7 k Ω
- Temperature = 50°C (system max.)
- VHOLD = 0V @ time = 0

EXAMPLE 18-1: CALCULATING THE MINIMUM REQUIRED ACQUISITION TIME

$$\begin{aligned} \text{TACQ} &= \text{TAMP} + \text{TC} + \text{Tcoff} \\ \text{Temperature coefficient is only required for temperatures} &> 25^\circ\text{C}. \\ \text{TACQ} &= 2 \mu\text{s} + \text{TC} + [(\text{Temp} - 25^\circ\text{C})(0.05 \mu\text{s}/^\circ\text{C})] \\ \text{TC} &= -\text{CHOLD} (\text{RIC} + \text{RSS} + \text{RS}) \ln(1/2048) \\ &= -120 \text{ pF} (1 \text{ k}\Omega + 7 \text{ k}\Omega + 2.5 \text{ k}\Omega) \ln(0.0004883) \\ &= -120 \text{ pF} (10.5 \text{ k}\Omega) \ln(0.0004883) \\ &= -1.26 \mu\text{s} (-7.6246) \\ &= 9.61 \mu\text{s} \\ \text{TACQ} &= 2 \mu\text{s} + 9.61 \mu\text{s} + [(50^\circ\text{C} - 25^\circ\text{C})(0.05 \mu\text{s}/^\circ\text{C})] \\ &= 11.61 \mu\text{s} + 1.25 \mu\text{s} \\ &= 12.86 \mu\text{s} \end{aligned}$$

19.1 Control Register

The Low Voltage Detect Control register controls the operation of the Low Voltage Detect circuitry.

REGISTER 19-1: LVDCON REGISTER

U-0	U-0	R-0	R/W-0	R/W-0	R/W-1	R/W-0	R/W-1
—	—	IRVST	LV DEN	LV DL3	LV DL2	LV DL1	LV DL0
bit 7		bit 0					

bit 7-6 **Unimplemented:** Read as '0'

bit 5 **IRVST:** Internal Reference Voltage Stable Flag bit
 1 = Indicates that the Low Voltage Detect logic will generate the interrupt flag at the specified voltage range
 0 = Indicates that the Low Voltage Detect logic will not generate the interrupt flag at the specified voltage range and the LVD interrupt should not be enabled

bit 4 **LV DEN:** Low Voltage Detect Power Enable bit
 1 = Enables LVD, powers up LVD circuit
 0 = Disables LVD, powers down LVD circuit

bit 3-0 **LV DL3:LV DL0:** Low Voltage Detection Limit bits
 1111 = External analog input is used (input comes from the LVDIN pin)
 1110 = 4.5V - 4.77V
 1101 = 4.2V - 4.45V
 1100 = 4.0V - 4.24V
 1011 = 3.8V - 4.03V
 1010 = 3.6V - 3.82V
 1001 = 3.5V - 3.71V
 1000 = 3.3V - 3.50V
 0111 = 3.0V - 3.18V
 0110 = 2.8V - 2.97V
 0101 = 2.7V - 2.86V
 0100 = 2.5V - 2.65V
 0011 = 2.4V - 2.54V
 0010 = 2.2V - 2.33V
 0001 = 2.0V - 2.12V
 0000 = Reserved

Note: LV DL3:LV DL0 modes, which result in a trip point below the valid operating voltage of the device, are not tested.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

20.0 SPECIAL FEATURES OF THE CPU

There are several features intended to maximize system reliability, minimize cost through elimination of external components, provide power saving Operating modes and offer code protection. These are:

- OSC Selection
- RESET
 - Power-on Reset (POR)
 - Power-up Timer (PWRT)
 - Oscillator Start-up Timer (OST)
 - Brown-out Reset (BOR)
- Interrupts
- Watchdog Timer (WDT)
- SLEEP
- Code Protection
- ID Locations
- In-Circuit Serial Programming

All PIC18FXX39 devices have a Watchdog Timer, which is permanently enabled via the configuration bits, or software controlled. It runs off its own RC oscillator for added reliability. There are two timers that offer necessary delays on power-up. One is the Oscillator Start-up Timer (OST), intended to keep the chip in RESET until the crystal oscillator is stable. The other is the Power-up Timer (PWRT), which provides a fixed delay on power-up only, designed to keep the part in RESET while the power supply stabilizes. With these two timers on-chip, most applications need no external RESET circuitry.

SLEEP mode is designed to offer a very low current Power-down mode. The user can wake-up from SLEEP through external RESET, Watchdog Timer Wake-up or through an interrupt. Several oscillator options are also made available to allow the part to fit the application. The RC oscillator option saves system cost, while the LP crystal option saves power. A set of configuration bits are used to select various options.

20.1 Configuration Bits

The configuration bits can be programmed (read as '0'), or left unprogrammed (read as '1'), to select various device configurations. These bits are mapped starting at program memory location 300000h.

The user will note that address 300000h is beyond the user program memory space. In fact, it belongs to the configuration memory space (300000h - 3FFFFh), which can only be accessed using Table Reads and Table Writes.

Programming the configuration registers is done in a manner similar to programming the FLASH memory (see Section 5.5.1). The only difference is the configuration registers are written a byte at a time. The sequence of events for programming configuration registers is:

1. Load table pointer with address of configuration register being written.
2. Write a single byte using the `TBLWT` instruction.
3. Set `EEPGD` to point to program memory, set the `CFGS` bit to access configuration registers, and set `WREN` to enable byte writes.
4. Disable interrupts.
5. Write 55h to `EECON2`.
6. Write AAh to `EECON2`.
7. Set the `WR` bit. This will begin the write cycle.
8. CPU will stall for duration of write (approximately 2 ms using internal timer).
9. Execute a `NOP`.
10. Re-enable interrupts.

20.3 Power-down Mode (SLEEP)

Power-down mode is entered by executing a `SLEEP` instruction.

If enabled, the Watchdog Timer will be cleared, but keeps running, the $\overline{PD}$ bit (RCON<3>) is cleared, the $\overline{TO}$ (RCON<4>) bit is set, and the oscillator driver is turned off. The I/O ports maintain the status they had before the `SLEEP` instruction was executed (driving high, low or hi-impedance).

For lowest current consumption in this mode, place all I/O pins at either V_{DD} or V_{SS} , ensure no external circuitry is drawing current from the I/O pin, power-down the A/D and disable external clocks. Pull all I/O pins that are hi-impedance inputs, high or low externally, to avoid switching currents caused by floating inputs. The $T0CKI$ input should also be at V_{DD} or V_{SS} for lowest current consumption. The contribution from on-chip pull-ups on $PORTB$ should be considered.

The $\overline{MCLR}$ pin must be at a logic high level (V_{IHMC}).

20.3.1 WAKE-UP FROM SLEEP

The device can wake-up from `SLEEP` through one of the following events:

1. External RESET input on $\overline{MCLR}$ pin.
2. Watchdog Timer Wake-up (if WDT was enabled).
3. Interrupt from INT pin, RB port change or a Peripheral Interrupt.

The following peripheral interrupts can wake the device from `SLEEP`:

1. PSP read or write.
2. TMR1 interrupt. Timer1 must be operating as an asynchronous counter.
3. TMR3 interrupt. Timer3 must be operating as an asynchronous counter.
4. CCP Capture mode interrupt.
5. Special event trigger (Timer1 in Asynchronous mode using an external clock).
6. MSSP (START/STOP) bit detect interrupt.
7. MSSP transmit or receive in Slave mode (SPI/I²C).
8. USART RX or TX (Synchronous Slave mode).
9. A/D conversion (when A/D clock source is RC).
10. EEPROM write operation complete.
11. LVD interrupt.

Other peripherals cannot generate interrupts, since during `SLEEP`, no on-chip clocks are present.

External $\overline{MCLR}$ Reset will cause a device RESET. All other events are considered a continuation of program execution and will cause a "wake-up". The $\overline{TO}$ and $\overline{PD}$ bits in the RCON register can be used to determine the cause of the device RESET. The $\overline{PD}$ bit, which is set on power-up, is cleared when `SLEEP` is invoked. The $\overline{TO}$ bit is cleared, if a WDT time-out occurred (and caused wake-up).

When the `SLEEP` instruction is being executed, the next instruction ($PC + 2$) is pre-fetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be set (enabled). Wake-up is regardless of the state of the GIE bit. If the GIE bit is clear (disabled), the device continues execution at the instruction after the `SLEEP` instruction. If the GIE bit is set (enabled), the device executes the instruction after the `SLEEP` instruction and then branches to the interrupt address. In cases where the execution of the instruction following `SLEEP` is not desirable, the user should have a `NOP` after the `SLEEP` instruction.

20.3.2 WAKE-UP USING INTERRUPTS

When global interrupts are disabled (GIE cleared) and any interrupt source has both its interrupt enable bit and interrupt flag bit set, one of the following will occur:

- If an interrupt condition (interrupt flag bit and interrupt enable bits are set) occurs **before** the execution of a `SLEEP` instruction, the `SLEEP` instruction will complete as a `NOP`. Therefore, the WDT and WDT postscaler will not be cleared, the $\overline{TO}$ bit will not be set and $\overline{PD}$ bits will not be cleared.
- If the interrupt condition occurs **during or after** the execution of a `SLEEP` instruction, the device will immediately wake-up from `SLEEP`. The `SLEEP` instruction will be completely executed before the wake-up. Therefore, the WDT and WDT postscaler will be cleared, the $\overline{TO}$ bit will be set and the $\overline{PD}$ bit will be cleared.

Even if the flag bits were checked before executing a `SLEEP` instruction, it may be possible for flag bits to become set before the `SLEEP` instruction completes. To determine whether a `SLEEP` instruction executed, test the $\overline{PD}$ bit. If the $\overline{PD}$ bit is set, the `SLEEP` instruction was executed as a `NOP`.

To ensure that the WDT is cleared, a `CLRWDT` instruction should be executed before a `SLEEP` instruction.

21.0 INSTRUCTION SET SUMMARY

The PIC18FXXX instruction set adds many enhancements to the previous PIC MCU instruction sets, while maintaining an easy migration from these PIC MCU instruction sets.

Most instructions are a single program memory word (16-bits), but there are three instructions that require two program memory locations.

Each single word instruction is a 16-bit word divided into an OPCODE, which specifies the instruction type and one or more operands, which further specify the operation of the instruction.

The instruction set is highly orthogonal and is grouped into four basic categories:

- **Byte-oriented** operations
- **Bit-oriented** operations
- **Literal** operations
- **Control** operations

The PIC18FXXX instruction set summary in Table 21-2 lists **byte-oriented**, **bit-oriented**, **literal** and **control** operations. Table 21-1 shows the opcode field descriptions.

Most **byte-oriented** instructions have three operands:

1. The file register (specified by 'f')
2. The destination of the result (specified by 'd')
3. The accessed memory (specified by 'a')

The file register designator 'f' specifies which file register is to be used by the instruction.

The destination designator 'd' specifies where the result of the operation is to be placed. If 'd' is zero, the result is placed in the WREG register. If 'd' is one, the result is placed in the file register specified in the instruction.

All **bit-oriented** instructions have three operands:

1. The file register (specified by 'f')
2. The bit in the file register (specified by 'b')
3. The accessed memory (specified by 'a')

The bit field designator 'b' selects the number of the bit affected by the operation, while the file register designator 'f' represents the number of the file in which the bit is located.

The **literal** instructions may use some of the following operands:

- A literal value to be loaded into a file register (specified by 'k')
- The desired FSR register to load the literal value into (specified by 'f')
- No operand required (specified by '—')

The **control** instructions may use some of the following operands:

- A program memory address (specified by 'n')
- The mode of the Call or Return instructions (specified by 's')
- The mode of the Table Read and Table Write instructions (specified by 'm')
- No operand required (specified by '—')

All instructions are a single word, except for three double-word instructions. These three instructions were made double-word instructions, so that all the required information is available in these 32 bits. In the second word, the 4 MSBs are '1's. If this second word is executed as an instruction (by itself), it will execute as a NOP.

All single word instructions are executed in a single instruction cycle, unless a conditional test is true or the program counter is changed as a result of the instruction. In these cases, the execution takes two instruction cycles with the additional instruction cycle(s) executed as a NOP.

The double-word instructions execute in two instruction cycles.

One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time is 1 μ s. If a conditional test is true, or the program counter is changed as a result of an instruction, the instruction execution time is 2 μ s. Two-word branch instructions (if true) would take 3 μ s.

Figure 21-1 shows the general formats that the instructions can have.

All examples use the format 'nnh' to represent a hexadecimal number, where 'h' signifies a hexadecimal digit.

The Instruction Set Summary, shown in Table 21-2, lists the instructions recognized by the Microchip Assembler (MPASM™).

Section 21.1 provides a description of each instruction.

INCFSZ		Increment f, skip if 0						
Syntax:	[<i>label</i>] INCFSZ f [,d [,a]							
Operands:	0 ≤ f ≤ 255 d ∈ [0,1] a ∈ [0,1]							
Operation:	(f) + 1 → dest, skip if result = 0							
Status Affected:	None							
Encoding:	<table border="1"><tr><td>0011</td><td>11da</td><td>ffff</td><td>ffff</td></tr></table>				0011	11da	ffff	ffff
0011	11da	ffff	ffff					
Description:	The contents of register 'f' are incremented. If 'd' is 0, the result is placed in W. If 'd' is 1, the result is placed back in register 'f'. (default) If the result is 0, the next instruction, which is already fetched, is discarded, and a NOP is executed instead, making it a two-cycle instruction. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' = 1, then the bank will be selected as per the BSR value (default).							
Words:	1							
Cycles:	1(2)							
	Note: 3 cycles if skip and followed by a 2-word instruction.							

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

If skip:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation
No operation	No operation	No operation	No operation

Example:

```

HERE    INCFSZ    CNT, 1, 0
NZERO   :
ZERO    :
```

Before Instruction

PC = Address (HERE)

After Instruction

```

CNT    = CNT + 1
If CNT = 0;
PC     = Address (ZERO)
If CNT ≠ 0;
PC     = Address (NZERO)
```

INFSNZ		Increment f, skip if not 0							
Syntax:	[<i>label</i>] INFSNZ f [,d [,a]								
Operands:	0 ≤ f ≤ 255 d ∈ [0,1] a ∈ [0,1]								
Operation:	(f) + 1 → dest, skip if result ≠ 0								
Status Affected:	None								
Encoding:	<table border="1"><tr><td>0100</td><td>10da</td><td>ffff</td><td>ffff</td></tr></table>					0100	10da	ffff	ffff
0100	10da	ffff	ffff						
Description:	The contents of register 'f' are incremented. If 'd' is 0, the result is placed in W. If 'd' is 1, the result is placed back in register 'f' (default). If the result is not 0, the next instruction, which is already fetched, is discarded, and a NOP is executed instead, making it a two-cycle instruction. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' = 1, then the bank will be selected as per the BSR value (default).								
Words:	1								
Cycles:	1(2)								
	Note: 3 cycles if skip and followed by a 2-word instruction.								

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

If skip:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation
No operation	No operation	No operation	No operation

Example:

```

HERE    INFSNZ    REG, 1, 0
ZERO    :
NZERO   :
```

Before Instruction

PC = Address (HERE)

After Instruction

```

REG    = REG + 1
If REG ≠ 0;
PC     = Address (NZERO)
If REG = 0;
PC     = Address (ZERO)
```

TSTFSZ Test f, skip if 0

Syntax: `[label] TSTFSZ f[,a]`

Operands: $0 \leq f \leq 255$
 $a \in [0,1]$

Operation: skip if $f = 0$

Status Affected: None

Encoding:

0110	011a	ffff	ffff
------	------	------	------

Description: If 'f' = 0, the next instruction, fetched during the current instruction execution, is discarded and a NOP is executed, making this a two-cycle instruction. If 'a' is 0, the Access Bank will be selected, overriding the BSR value. If 'a' is 1, then the bank will be selected as per the BSR value (default).

Words: 1

Cycles: 1(2)
Note: 3 cycles if skip and followed by a 2-word instruction.

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	No operation

If skip:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation
No operation	No operation	No operation	No operation

Example:

```

HERE    TSTFSZ  CNT, 1
NZERO   :
ZERO    :
```

Before Instruction

PC = Address (HERE)

After Instruction

```

If CNT = 0x00,
PC      = Address (ZERO)
If CNT ≠ 0x00,
PC      = Address (NZERO)
```

XORLW Exclusive OR literal with W

Syntax: `[label] XORLW k`

Operands: $0 \leq k \leq 255$

Operation: $(W) .XOR. k \rightarrow W$

Status Affected: N, Z

Encoding:

0000	1010	kkkk	kkkk
------	------	------	------

Description: The contents of W are XORed with the 8-bit literal 'k'. The result is placed in W.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Process Data	Write to W

Example: `XORLW 0xAF`

Before Instruction

W = 0xB5

After Instruction

W = 0x1A

FIGURE 24-13: TYPICAL, MINIMUM AND MAXIMUM V_{OH} vs. I_{OH} ($V_{DD} = 3V$, $-40^{\circ}C$ TO $+125^{\circ}C$)

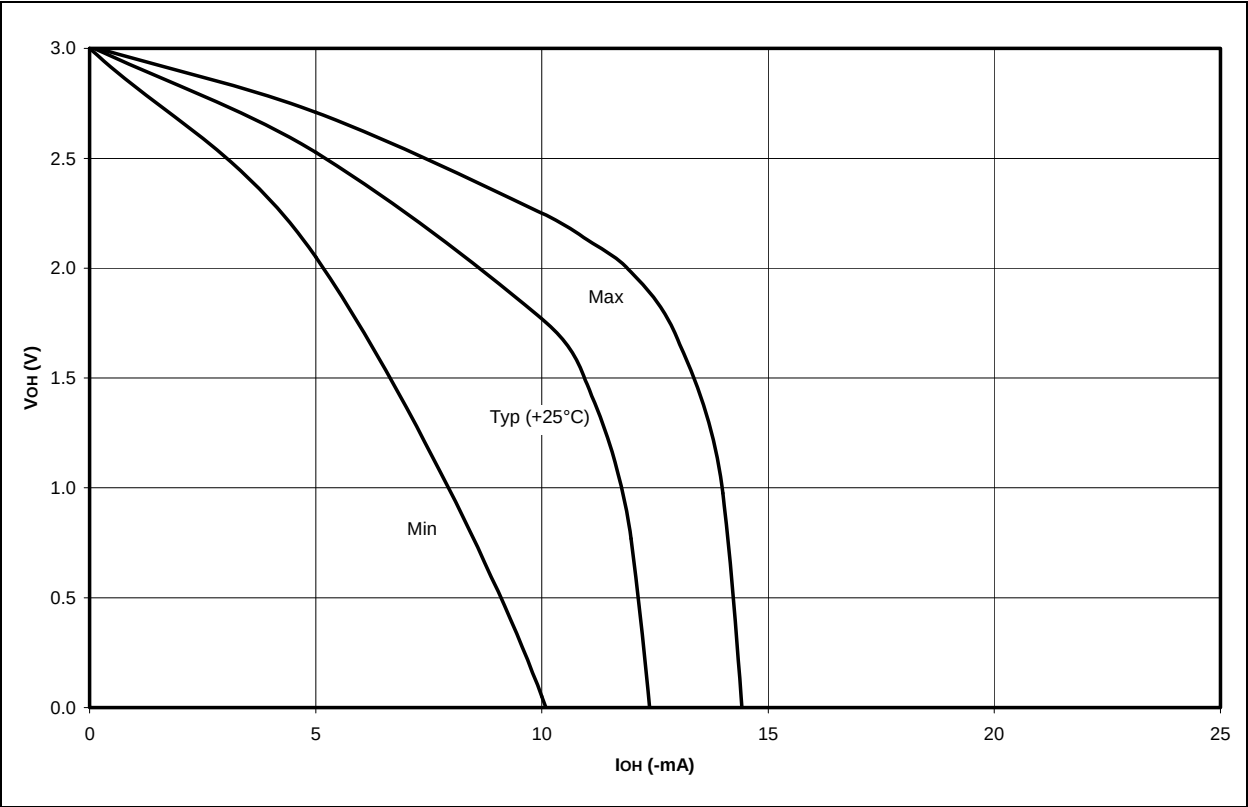
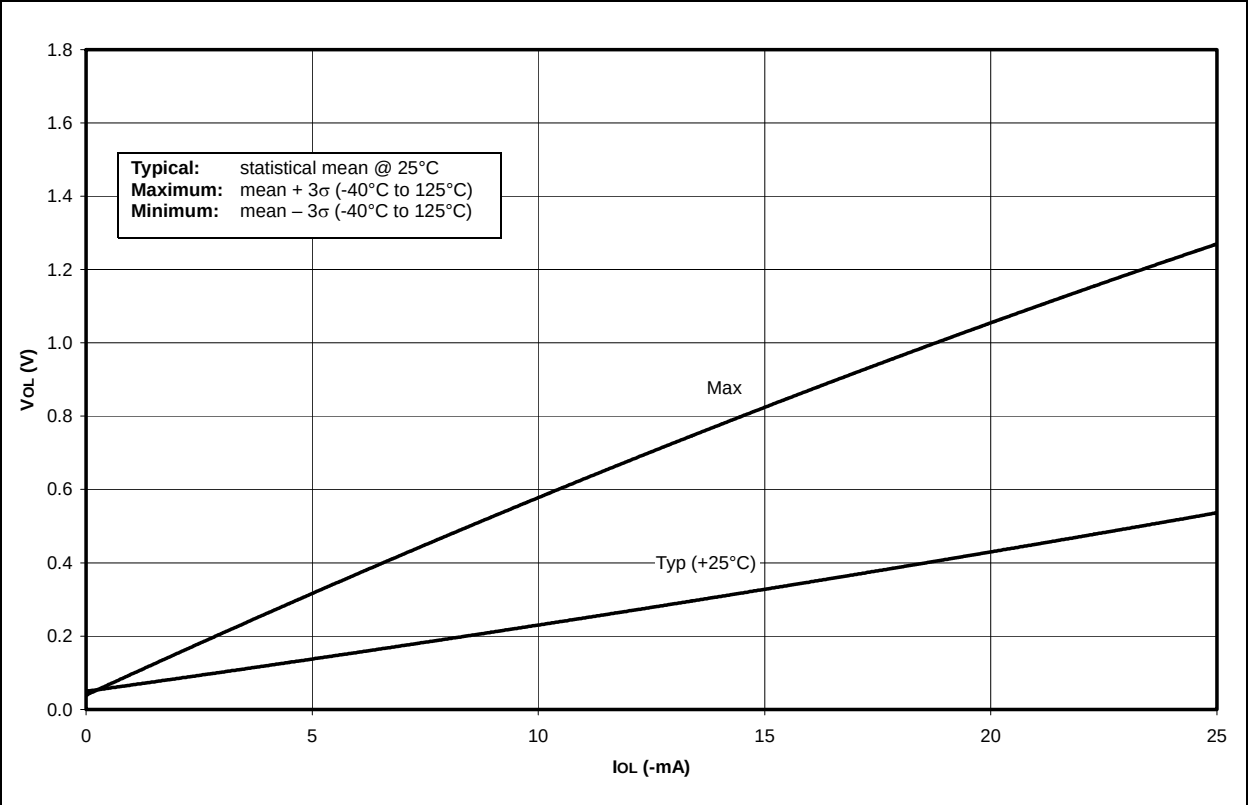


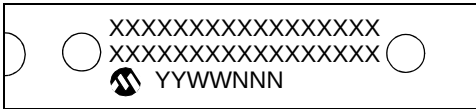
FIGURE 24-14: TYPICAL AND MAXIMUM V_{OL} vs. I_{OL} ($V_{DD} = 5V$, $-40^{\circ}C$ TO $+125^{\circ}C$)



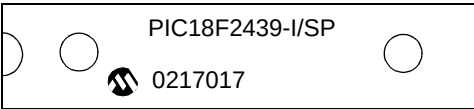
25.0 PACKAGING INFORMATION

25.1 Package Marking Information

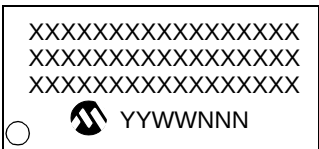
28-Lead PDIP (Skinny DIP)



Example



28-Lead SOIC



Example



Legend:

XX...X	Customer-specific information
Y	Year code (last digit of calendar year)
YY	Year code (last 2 digits of calendar year)
WW	Week code (week of January 1 is week '01')
NNN	Alphanumeric traceability code
(e3)	Pb-free JEDEC designator for Matte Tin (Sn)
*	This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.

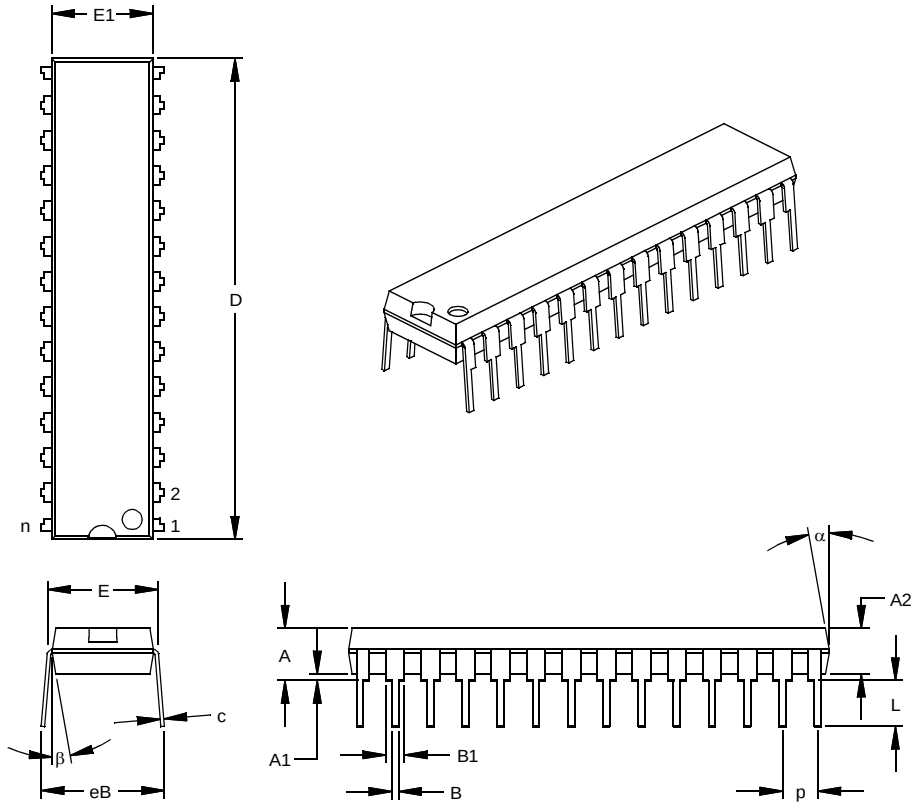
Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

25.2 Package Details

The following sections give the technical details of the packages.

28-Lead Skinny Plastic Dual In-line (SP) – 300 mil (PDIP)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		28			28	
Pitch	p		.100			2.54	
Top to Seating Plane	A	.140	.150	.160	3.56	3.81	4.06
Molded Package Thickness	A2	.125	.130	.135	3.18	3.30	3.43
Base to Seating Plane	A1	.015			0.38		
Shoulder to Shoulder Width	E	.300	.310	.325	7.62	7.87	8.26
Molded Package Width	E1	.275	.285	.295	6.99	7.24	7.49
Overall Length	D	1.345	1.365	1.385	34.16	34.67	35.18
Tip to Seating Plane	L	.125	.130	.135	3.18	3.30	3.43
Lead Thickness	c	.008	.012	.015	0.20	0.29	0.38
Upper Lead Width	B1	.040	.053	.065	1.02	1.33	1.65
Lower Lead Width	B	.016	.019	.022	0.41	0.48	0.56
Overall Row Spacing	§ eB	.320	.350	.430	8.13	8.89	10.92
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

* Controlling Parameter

§ Significant Characteristic

Notes:

Dimension D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MO-095

Drawing No. C04-070